

MGP15N43CL, MGB15N43CL

Preferred Device

Ignition IGBT 15 Amps, 430 Volts N-Channel TO-220 and D²PAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage to Interface Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|--|-----------------------------------|---------------|-----------------|
| Collector-Emitter Voltage | V _{CE(S)} | 460 | V _{DC} |
| Collector-Gate Voltage | V _{CER} | 460 | V _{DC} |
| Gate-Emitter Voltage | V _{GE} | 22 | V _{DC} |
| Collector Current-Continuous @ T _C = 25°C | I _C | 15 | A _{DC} |
| Total Power Dissipation @ T _C = 25°C Derate above 25°C | P _D | 136 1.0 | Watts W/°C |
| Operating and Storage Temperature Range | T _J , T _{stg} | -55 to 175 | °C |

UNCLAMPED DRAIN-TO-SOURCE AVALANCHE CHARACTERISTICS (T_J < 150°C)

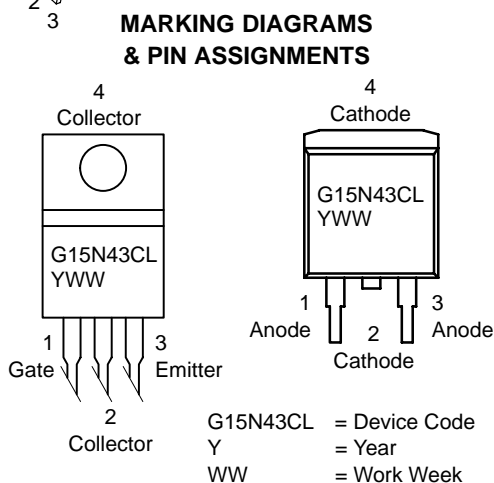
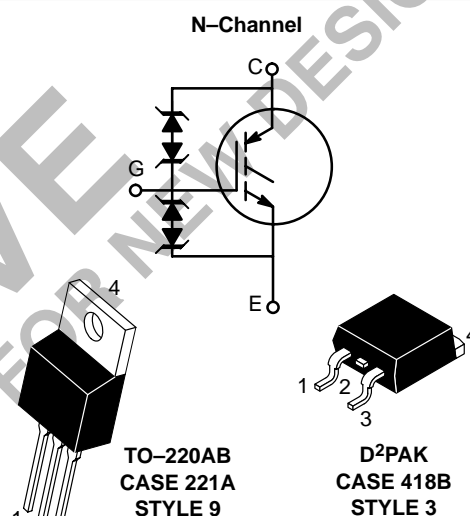
| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Single Pulse Collector-to-Emitter Avalanche Energy V _{CC} = 50 V, V _{GE} = 5 V, Pk I _L = 14.2 A, L = 3 mH, Starting T _J = 25°C | E _{AS} | 300 | mJ |
| V _{CC} = 50 V, V _{GE} = 5 V, Pk I _L = 10 A, L = 3 mH, Starting T _J = 150°C | | 150 | |



ON Semiconductor™

<http://onsemi.com>

15 AMPERES
430 VOLTS (Clamped)
V_{CE(on)} = 1.8 mΩ



ORDERING INFORMATION

| Device | Package | Shipping |
|--------------|---------|-----------------|
| MGP15N43CL | TO-220 | 50 Units/Rail |
| MGB15N43CLT4 | D2PAK | 800 Tape & Reel |

Preferred devices are recommended choices for future use and best overall value.

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THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|---------------------------------------|-------|------|
| Thermal Resistance, Junction to Case | $R_{\theta JC}$ | 1.0 | °C/W |
| Thermal Resistance, Junction to Ambient | TO-220 $R_{\theta JA}$ | 62.5 | |
| | D ² PAK $R_{\theta JA}$ | 50 | |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | T_L | 275 | °C |

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Min | Typ | Max | Unit |
|----------------|--------|-----------------|-----|-----|-----|------|
|----------------|--------|-----------------|-----|-----|-----|------|

OFF CHARACTERISTICS

| | | | | | | |
|---|------------|---|-----|-----|-----|--------------------|
| Collector-Emitter Clamp Voltage | BV_{CES} | $I_C = 2\text{ mA}$ $T_J = -40^\circ\text{C}$ to 175°C | 400 | 430 | 460 | V_{DC} |
| Zero Gate Voltage Collector Current | I_{CES} | $V_{CE} = 300\text{ V}$, $V_{GE} = 0$, $T_J = 25^\circ\text{C}$ | - | - | 40 | μA_{DC} |
| | | $V_{CE} = 300\text{ V}$, $V_{GE} = 0$, $T_J = 150^\circ\text{C}$ | - | - | 200 | |
| Reverse Collector-Emitter Leakage Current | I_{ECS} | $V_{CE} = -24\text{ V}$ | - | - | 1.0 | mA |
| Gate-Emitter Clamp Voltage | BV_{GES} | $I_G = 5\text{ mA}$ | 17 | - | 22 | V_{DC} |
| Gate-Emitter Leakage Current | I_{GES} | $V_{GE} = 10\text{ V}$ | - | - | 2.0 | μA_{DC} |

ON CHARACTERISTICS (Note 1.)

| | | | | | | |
|--|--------------|---|-----|-----|-----|----------------------------|
| Gate Threshold Voltage | $V_{GE(th)}$ | $I_C = 1\text{ mA}$ $V_{GE} = V_{CE}$ | 1.2 | 1.5 | 2.1 | V_{DC} |
| Threshold Temperature Coefficient (Negative) | - | - | - | 4.4 | - | $\text{mV}/^\circ\text{C}$ |
| Collector-to-Emitter On-Voltage | $V_{CE(on)}$ | $I_C = 6\text{ A}$, $V_{GE} = 4\text{ V}$ | - | - | 1.8 | V_{DC} |
| Collector-to-Emitter On-Voltage | $V_{CE(on)}$ | $I_C = 10\text{ A}$, $V_{GE} = 4.5\text{ V}$, $T_J = 150^\circ\text{C}$ | - | - | 1.8 | V_{DC} |
| Forward Transconductance | gfs | $V_{CE} = 5\text{ V}$, $I_C = 6\text{ A}$ | 8.0 | 15 | - | Mhos |

DYNAMIC CHARACTERISTICS

| | | | | | | |
|----------------------|-----------|------------------------|---|-----|---|----|
| Input Capacitance | C_{ISS} | $V_{CC} = 15\text{ V}$ | - | 950 | - | pF |
| Output Capacitance | C_{OSS} | $V_{GE} = 0\text{ V}$ | - | 100 | - | |
| Transfer Capacitance | C_{RSS} | $f = 1\text{ MHz}$ | - | 8.0 | - | |

SWITCHING CHARACTERISTICS (Note 1.)

| | | | | | | |
|---------------------|--------------|--|---|-----|---|-----------------|
| Turn-Off Delay Time | $t_{d(off)}$ | $V_{CC} = 300\text{ V}$, $I_C = 10\text{ A}$ | - | 14 | - | μSec |
| Fall Time | t_f | $R_G = 1\text{ k}\Omega$, $L = 300\text{ }\mu\text{H}$ | - | 7.0 | - | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{CC} = 10\text{ V}$, $I_C = 6.5\text{ A}$ | - | 0.5 | - | μSec |
| Rise Time | t_r | $R_G = 1\text{ k}\Omega$, $R_L = 1\text{ }\Omega$ | - | 4.5 | - | |
| Gate Charge | Q_T | $V_{CC} = 300\text{ V}$ | - | TBD | - | nC |
| | Q_1 | $I_C = 15\text{ A}$ | - | TBD | - | |
| | Q_2 | $V_{GE} = 5\text{ V}$ | - | TBD | - | |

1. Pulse Test: Pulse Width $\leq 300\text{ }\mu\text{s}$, Duty Cycle $\leq 2\%$.

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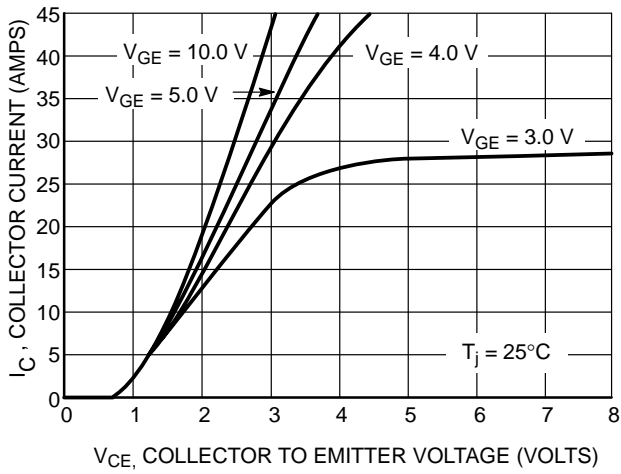


Figure 1. Output Characteristics

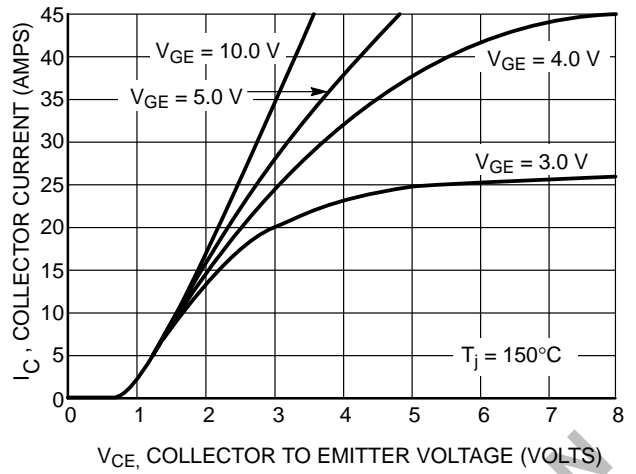


Figure 2. Output Characteristics

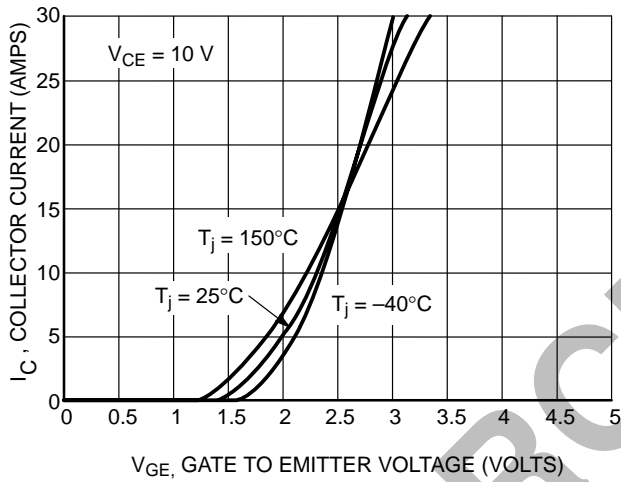


Figure 3. Transfer Characteristics

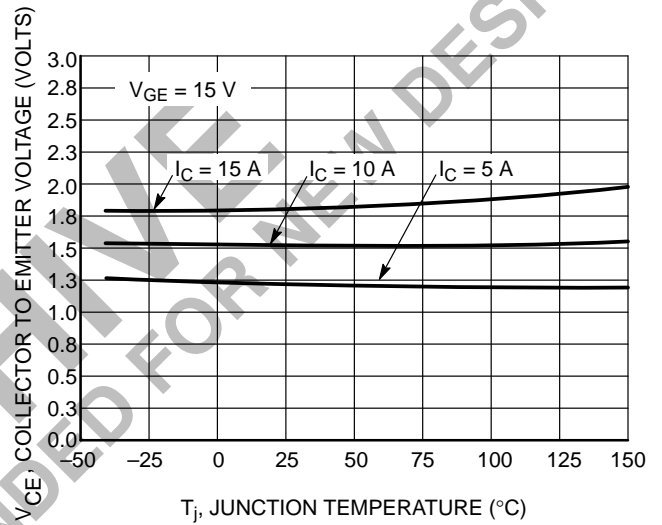


Figure 4. Collector-to-Emitter Saturation Voltage versus Junction Temperature

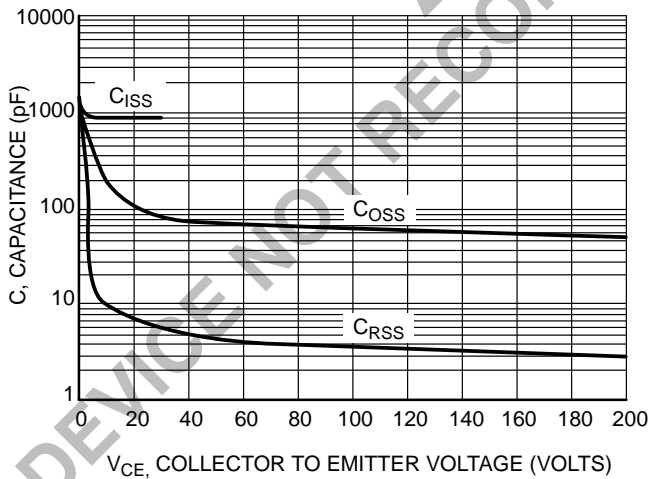


Figure 5. Capacitance Variation

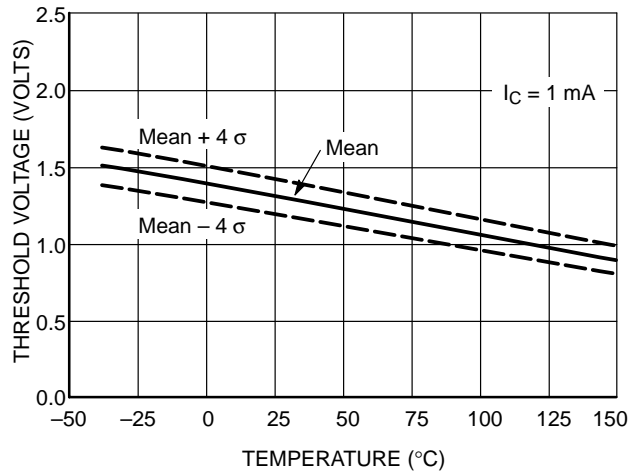


Figure 6. Threshold Voltage versus Temperature

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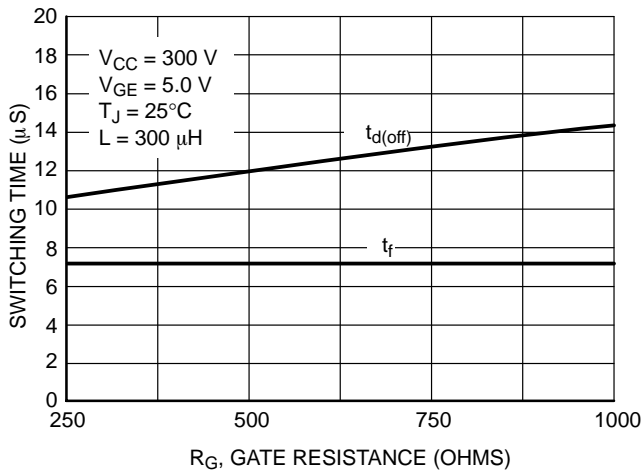


Figure 7. Switching Speed versus Gate Resistance

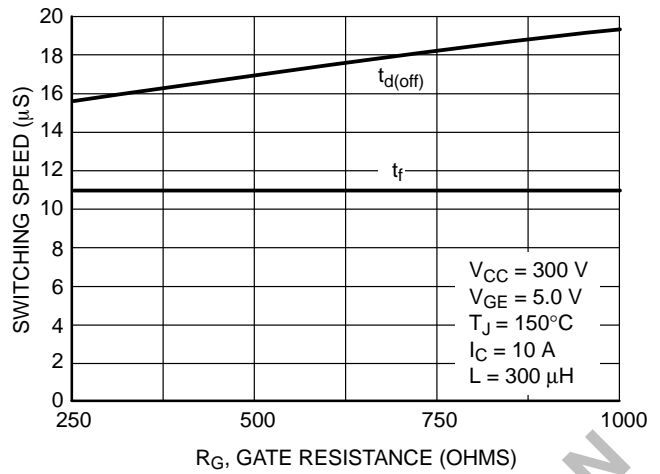


Figure 8. Switching Speed versus Gate Resistance

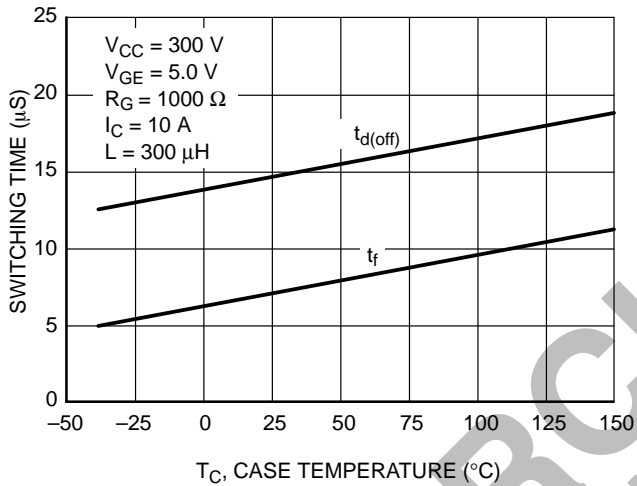


Figure 9. Switching Speed versus Case Temperature

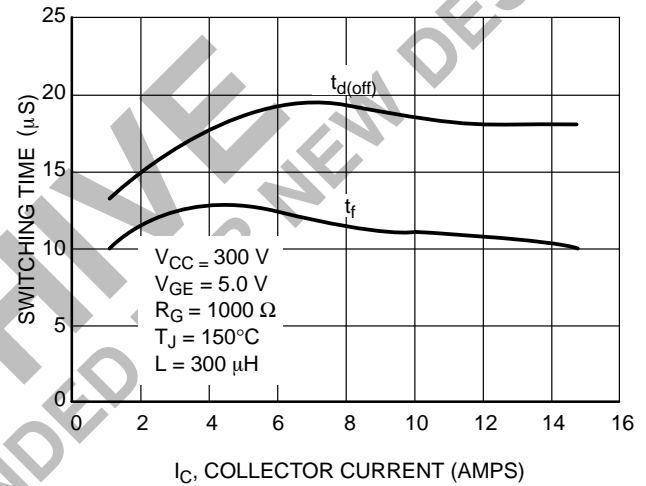


Figure 10. Total Switching Losses versus Collector Current

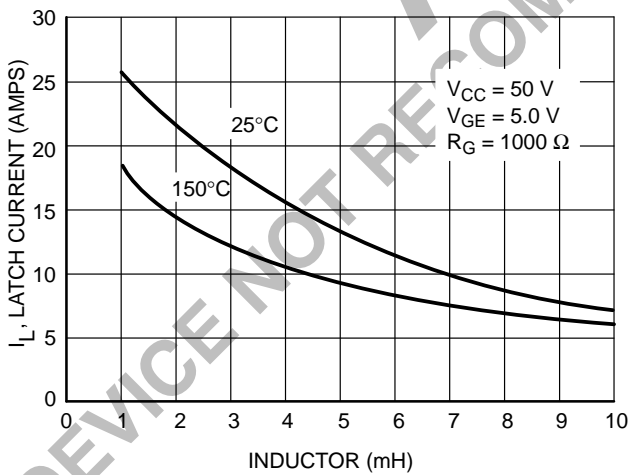


Figure 11. Latch Current versus Inductor (Typical)

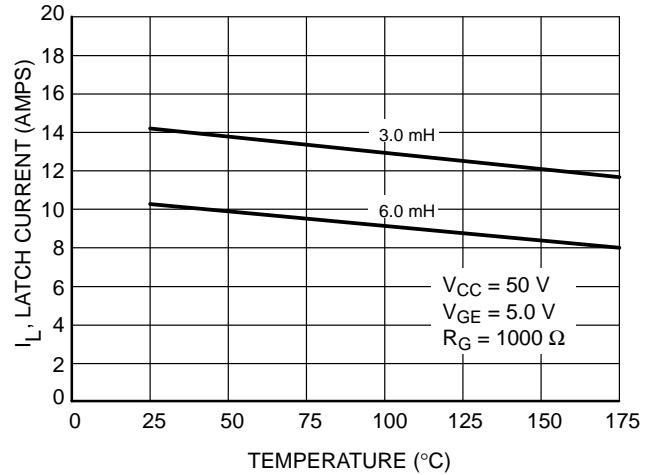
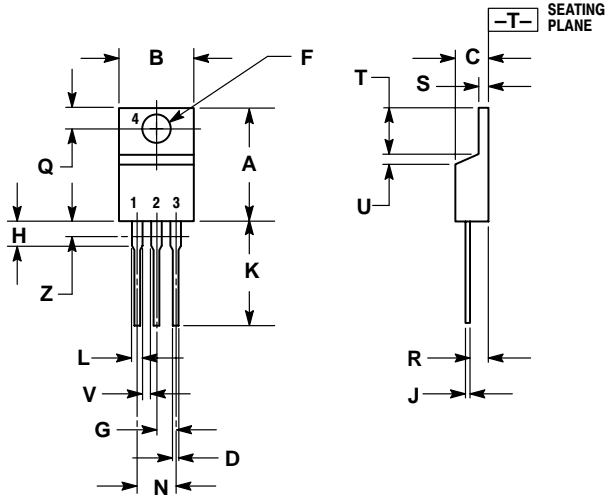


Figure 12. Latch Current versus Temperature (Typical)

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PACKAGE DIMENSIONS

TO-220 THREE-LEAD
TO-220AB
CASE 221A-09
ISSUE AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.405 | 9.66 | 10.28 |
| C | 0.160 | 0.190 | 4.07 | 4.82 |
| D | 0.025 | 0.035 | 0.64 | 0.88 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.155 | 2.80 | 3.93 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 9:

1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

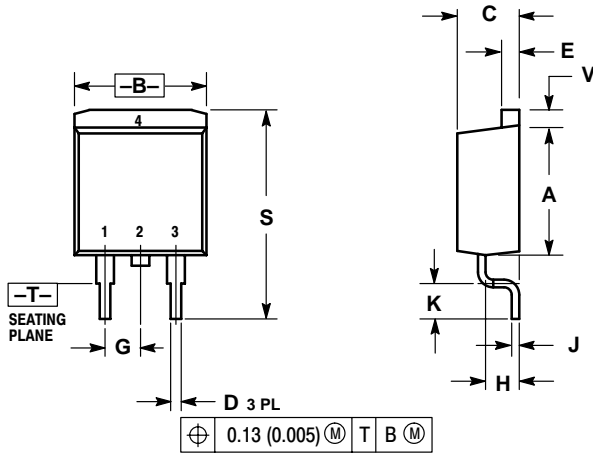
ARCHIVE FOR REDESIGN

DEVICE NOT RECOMMENDED FOR NEW DESIGN

MGP15N43CL, MGB15N43CL

PACKAGE DIMENSIONS

D²PAK
CASE 418B-03
ISSUE D



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.


| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.340 | 0.380 | 8.64 | 9.65 |
| B | 0.380 | 0.405 | 9.65 | 10.29 |
| C | 0.160 | 0.190 | 4.06 | 4.83 |
| D | 0.020 | 0.035 | 0.51 | 0.89 |
| E | 0.045 | 0.055 | 1.14 | 1.40 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.080 | 0.110 | 2.03 | 2.79 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.090 | 0.110 | 2.29 | 2.79 |
| S | 0.575 | 0.625 | 14.60 | 15.88 |
| V | 0.045 | 0.055 | 1.14 | 1.40 |

STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

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DEVICE NOT RECOMMENDED FOR NEW DESIGN

Notes

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